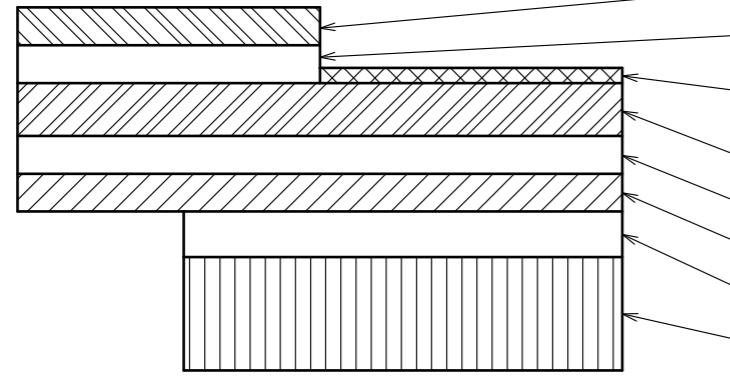


FPC CONFIGURATION (REFERENCE EXAMPLE)

(SCALE:FREE)

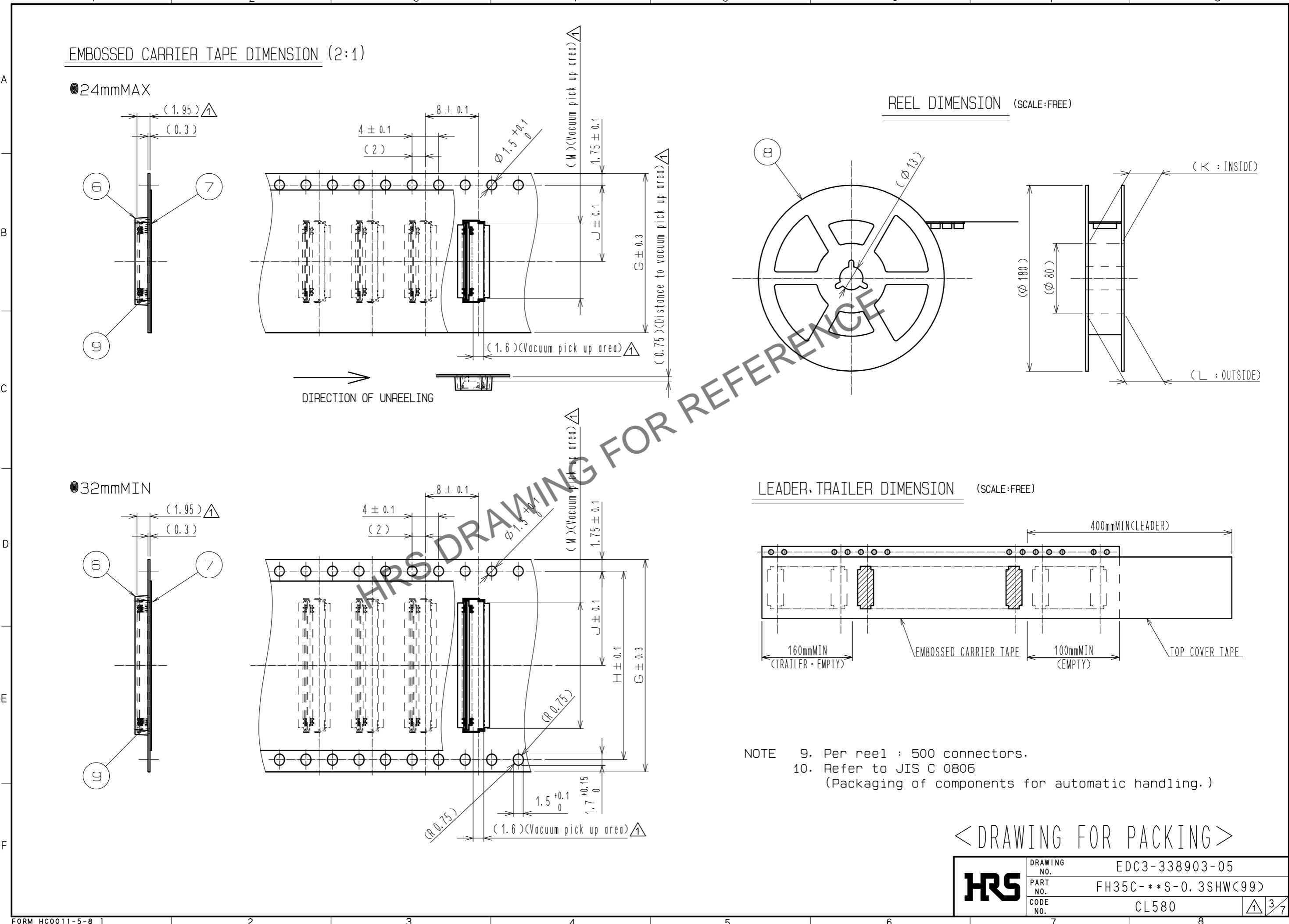


MATERIAL NAME	MATERIAL	THICKNESS(μm)
COVERING FILM LAYER	POLYIMIDE 1mil thick.	25
COVER ADHESIVE		25
SURFACE TREATMENT	1μm to 5μm NICKEL UNDERPLATED 0.2μm GOLD PLATED	(3)
COPPER FOIL	Cu 1 oz	35
BASE ADHESIVE	HEAT-HARDENED ADHESIVE	25
BASE FILM	POLYIMIDE 1mil thick	25
REINFORCEMENT MATERIAL ADHESIVE	HEAT-HARDENED ADHESIVE	40
STIFFENER	POLYIMIDE 3mil thick	75

EDC3-338903-05

HRS

DRAWING NO.	EDC3-338903-05
PART NO.	FH35C-**S-0.3SHW(99)
CODE NO.	CL580
1 2 7	



PART NUMBER	CODE NUMBER	NUMBER OF CONTACTS	DIMENSION OF CONNECTOR, FPC, PCB MOUNTING PATTERN AND STENCIL						DIMENSION OF DRAWING FOR PACKING					
			A	B	C	D	E	F	G	H	J	K	L	M
FH35C- 9S-0. 3SHW(99)	CL580-2910-5-99	9	4.3	1.8	2.4	3.03	3.73	3.0	16	—	7.5	17.4	21.4	3.46
FH35C-11S-0. 3SHW(99)	CL580-2917-4-99	11	4.9	2.4	3.0	3.63	4.33	3.6	16	—	7.5	17.4	21.4	4.06
FH35C-13S-0. 3SHW(99)	CL580-2925-2-99	13	5.5	3.0	3.6	4.23	4.93	4.2	16	—	7.5	17.4	21.4	4.66
FH35C-15S-0. 3SHW(99)	CL580-2919-0-99	15	6.1	3.6	4.2	4.83	5.53	4.8	16	—	7.5	17.4	21.4	5.26
FH35C-17S-0. 3SHW(99)	CL580-2916-1-99	17	6.7	4.2	4.8	5.43	6.13	5.4	16	—	7.5	17.4	21.4	5.86
FH35C-19S-0. 3SHW(99)	CL580-2921-1-99	19	7.3	4.8	5.4	6.03	6.73	6.0	16	—	7.5	17.4	21.4	6.46
FH35C-21S-0. 3SHW(99)	CL580-2922-4-99	21	7.9	5.4	6.0	6.63	7.33	6.6	24	—	11.5	25.4	29.4	7.06
FH35C-23S-0. 3SHW(99)	CL580-2911-8-99	23	8.5	6.0	6.6	7.23	7.93	7.2	24	—	11.5	25.4	29.4	7.66
FH35C-25S-0. 3SHW(99)	CL580-2912-0-99	25	9.1	6.6	7.2	7.83	8.53	7.8	24	—	11.5	25.4	29.4	8.26
FH35C-27S-0. 3SHW(99)	CL580-2918-7-99	27	9.7	7.2	7.8	8.43	9.13	8.4	24	—	11.5	25.4	29.4	8.86
FH35C-31S-0. 3SHW(99)	CL580-2923-7-99	31	10.9	8.4	9.0	9.63	10.33	9.6	24	—	11.5	25.4	29.4	10.06
FH35C-33S-0. 3SHW(99)	CL580-2913-3-99	33	11.5	9.0	9.6	10.23	10.93	10.2	24	—	11.5	25.4	29.4	10.66
FH35C-35S-0. 3SHW(99)	CL580-2926-5-99	35	12.1	9.6	10.2	10.83	11.53	10.8	24	—	11.5	25.4	29.4	11.26
FH35C-37S-0. 3SHW(99)	CL580-2914-6-99	37	12.7	10.2	10.8	11.43	12.13	11.4	24	—	11.5	25.4	29.4	11.86
FH35C-39S-0. 3SHW(99)	CL580-2915-9-99	39	13.3	10.8	11.4	12.03	12.73	12.0	24	—	11.5	25.4	29.4	12.46
FH35C-41S-0. 3SHW(99)	CL580-2924-0-99	41	13.9	11.4	12.0	12.63	13.33	12.6	24	—	11.5	25.4	29.4	13.06
FH35C-45S-0. 3SHW(99)	CL580-2909-6-99	45	15.1	12.6	13.2	13.83	14.53	13.8	24	—	11.5	25.4	29.4	14.26
FH35C-49S-0. 3SHW(99)	CL580-2927-8-99	49	16.3	13.8	14.4	15.03	15.73	15.0	32	28.4	14.2	33.4	37.4	15.46
FH35C-51S-0. 3SHW(99)	CL580-2920-9-99	51	16.9	14.4	15.0	15.63	16.33	15.6	32	28.4	14.2	33.4	37.4	16.06
FH35C-55S-0. 3SHW(99)	CL580-2931-5-99	55	18.1	15.6	16.2	16.83	17.53	16.8	32	28.4	14.2	33.4	37.4	17.26
FH35C-61S-0. 3SHW(99)	CL580-2928-0-99	61	19.9	17.4	18.0	18.63	19.33	18.6	32	28.4	14.2	33.4	37.4	19.06

< DIMENSION TABLE >

	DRAWING NO.	EDC3-338903-05
	PART NO.	FH35C-**S-0. 3SHW(99)
	CODE NO.	CL580
		1 4 7

This connector features small, thin and back flip design, requiring delicate and careful handling.

Read through the instructions shown below and handle the connector properly.

A

6. How to FPC routing

Do not apply load to FPC when locating FPC.

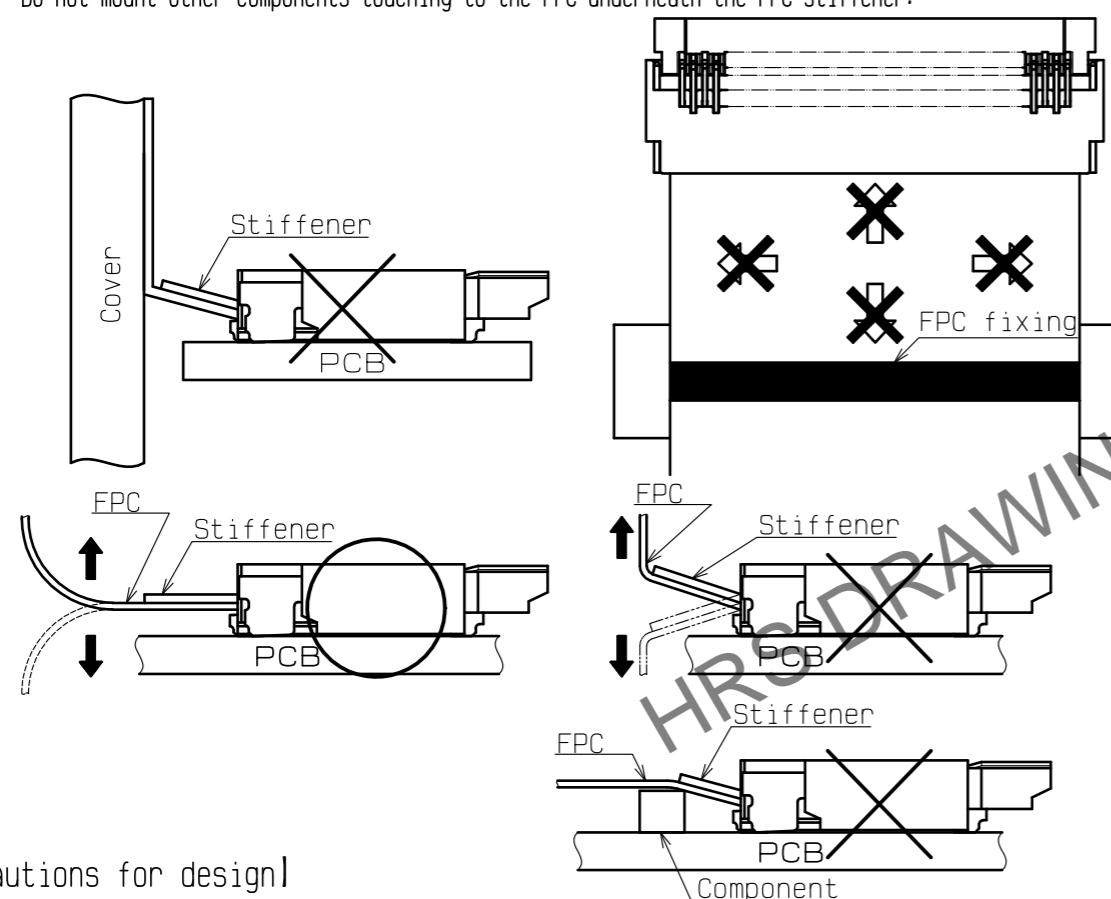
It leads to the disconnection break or damage of FPC.

In addition, there is possibility to make a conduction failure if applying load to connector.

B

[Prohibited acts]

- Please design FPC routing so that FPC stiffener will not interfere with cover case.
- When fixing FPC, avoid applying forces to FPC in vertical or horizontal directions.
In addition, avoid pulling up and down on the FPC.
- When fixing FPC after FPC cabling, avoid pulling FPC, and route the wire FPC with slack.
In this regard, the stiffener is parallel to the PCB.
- Do not mount other components touching to the FPC underneath the FPC stiffener.



C

D

E

F

[Precautions for design]

1. During FPC wiring, ensure that stress is not applied directly to the connector.
Do not bend the FPC excessively near the connector during use, or it may cause contact failure or FPC breakage.
Stabilizing the FPC is recommended.
2. Keep a sufficient FPC insertion space in the stage of the layout in order to avoid incorrect FPC insertion.
Appropriate FPC length and component layout are recommended for assembly ease.
Too short FPC length makes assembly difficult.
3. Follow the recommended PCB layout, FPC design and the stencil opening design.
4. Make adjustments with the FPC manufacturer for FPC bending performance and wire breakage.
5. Keep spaces for the actuator movement and its operation for PCB design and component layout.
6. Please consult with our sales representative if you are using FPC with different configuration from our recommendation.

[Instructions for mounting on the PCB]

⚠ Warp of PCB

- Minimize warp of the PCB as much as possible.
Lead co-planarity including reinforced metal fittings is 0.1 mm or less.
Too much warp of the PCB may result in a soldering failure.
- Clearance between the mounting surface of the connector contact lead and the bottom of the housing is (0.03).
Solder resist/silk screening applied underneath the connector may interfere with the connector.
This may lead to soldering defect/insufficient fillet formation.
- Please verify your solder resist/silk screening design carefully before implementing the design.

♦ Flexible board design

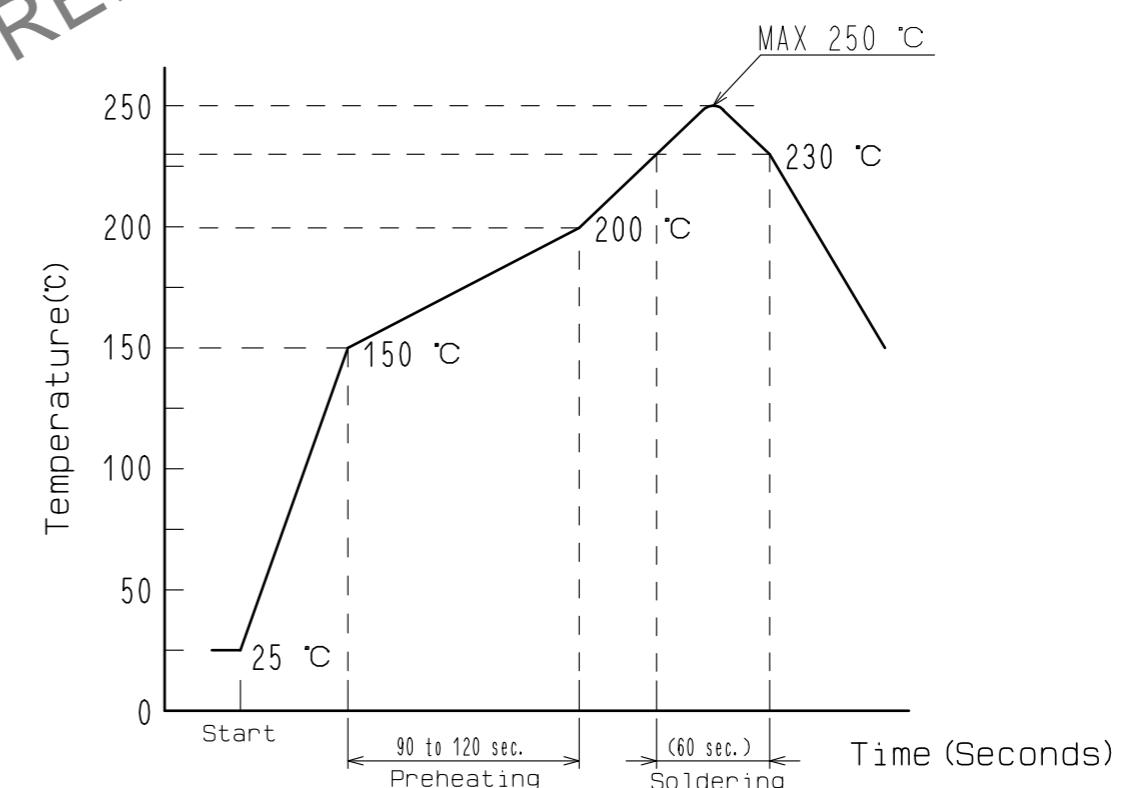
- Please make sure to put a stiffener on the backside of the flexible board.
We recommend a glass epoxy material with the thickness of 0.3mm MIN.

♦ Load to Connector

- Do not add 0.5N or greater external force when unreel or pick and place the connector etc, or it may get broken.
In addition, do not insert the FPC or operate the connector before mounting.

⚠ Reflow temperature profile

- Apply reflow temperature profile within the specified conditions.
For specific applications, the recommended temperature may vary depending on type/volume/thickness of solder paste and size/thickness of PCB.
Please consult with your solder paste and equipment manufacturer for specific recommendations.
The temperatures mentioned below refer to the PCB surface temperature near the connector contact leads.
- Reflow method: IR reflow
- Number of reflow cycles: 2 cycles MAX.



< INSTRUCTION MANUAL(2) >

HRS	DRAWING NO. EDC3-338903-05
	PART NO. FH35C-**S-0.3SHW(99)
	CODE NO. CL580

[INSTRUCTIONS FOR PCB HANDLING AFTER MOUNTING THE CONNECTOR]

◆Load to PCB

-Splitting a large PCB into several pieces

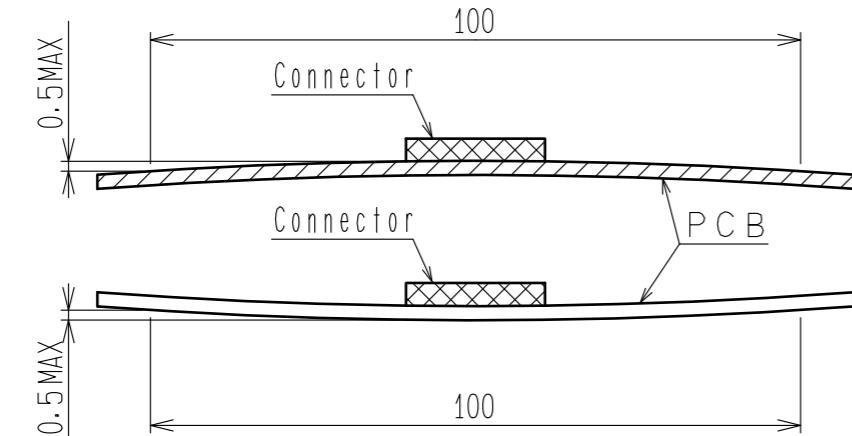
-Screwing the PCB

Avoid the handling described above so that no force is exerted on the PCB during the assembly process.
Otherwise, the connector may become defective.

◆Amount of Warp

The warp of a 100mm wide PCB should be 0.5 mm or less.

The warp of PCB suffers stress on connector and the connector may become defective.

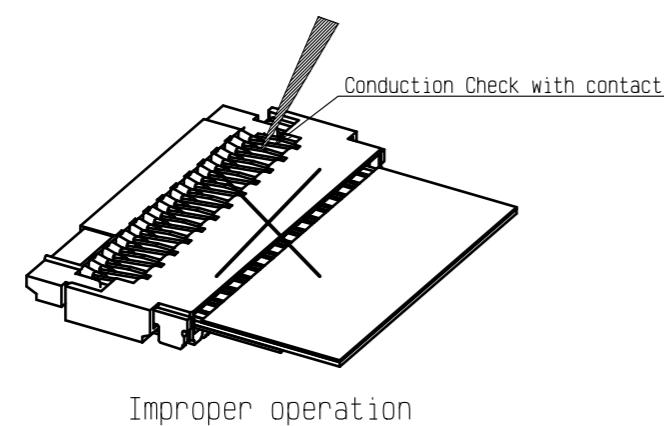


[Other instructions]

◆Instructions on manual soldering

Follow the instructions shown below when soldering the connector manually during repair work, etc.

1. Do not perform manual soldering with the FPC inserted into the connector.
2. Do not heat the connector excessively. Be very careful not to let the soldering iron contact any parts other than connector leads. Otherwise, the connector may be deformed or melt.
3. Do not supply excessive solder (or flux).
If excessive solder (or flux) is supplied on the terminals, solder or flux may adhere to the contacts or rotating parts of the actuator, resulting in poor contact or a rotation failure of the actuator.
Supplying excessive solder to the metal fittings may hinder actuator rotation, resulting in breakage of the connector.
4. Attachment of foreign particles with the connector contact may lead to conduction failure.
In this particular case, the conduction failure may be fixed by re-inserting the FPC.
5. Please perform conduction check with caution. Conductivity probe may damage the connector contacts.



<INSTRUCTION MANUAL(3)>

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	PART NO. FH35C-**S-0.3SHW(99)
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	7 7